Innovating Energy Technology

FMW60N075S2FDHF

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FUJI POWER MOSFET

Super J MOS® S2 series

N-Channel enhancement mode power MOSFET

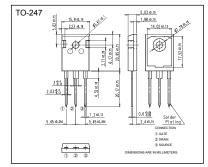
Features

Pb-free lead terminal RoHS compliant uses Halogen-free molding compound

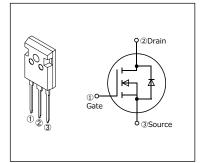
Applications

For switching

Outline Drawings [mm]



Equivalent circuit schematic



■ Absolute Maximum Ratings at T_{vi}=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Drain Current	I _D	53.2	Α	<i>T</i> _{vj} =25°C Note*1,2
Continuous Drain Current		33.6	Α	T _{vj} =100°C Note*1,2
Pulsed Drain Current	I DP	158	Α	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	I AS	6.3	А	Note *3
Non-Repetitive Maximum Avalanche Energy	E as	1305	mJ	Note *4
Maximum Drain-Source dV/dt	d <i>V</i> ⊳s/dt	50	V/ns	V _{DS} ≤ 600V
Continuous		53.2	Α	<i>T</i> _{vj} =25°C Note*1,2
Diode Forward Current	I sp	33.6	Α	<i>T</i> _{vj} =100°C Note*1,2
Pulsed Diode Forward Current	I SDP	158	Α	Note *2
Peak Diode Recovery dV/dt	dV/dt	30	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
Mandanana Barran Birada adian	Po	2.5	W	<i>T</i> _a =25°C
Maximum Power Dissipation	I P D	270	VV	<i>T</i> _{vj} =25°C
Operating and Storage Temperature renge	T _{ch}	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.55

Note *1: Imiximum duty cycle D=0.50 Note *2: Limited by maximum channel temperature. Note *3: $T_{ch} \le 150^{\circ}$ C, See Fig.1 and Fig.2 Note *4: Starting $T_{ch} = 25^{\circ}$ C, $I_{ch} \le 1.8$ As $I_{ch} = 166$ MH, $I_{ch} = 160$ MH, $I_{ch} = 1$

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■ Electrical Characteristics at *T*_{vj}=25°C (unless otherwise specified) • Static Ratings

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{cs} =0V I _D =250μA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =6.4mA		3.0	4.0	5.0	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μА
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	60	-	
Gate-Source Leakage Current	I GSS	V _{DS} =0V V _{GS} = ± 30V	·	-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V I _D =19.7A		-	0.065	0.075	Ω
Gate resistance	R _G	f=1MHz, open drain		-	6.9	_	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g fs	V _{DS} =25V I _D =19.7A	13.5	27	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	2220	-	
Output Capacitance	Coss	V _{GS} =0V	-	76	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	9.3	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} =0400V V _{GS} =0V	-	173	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	V _{DS} =0400V V _{GS} =0V J _D =constant	-	722	-	
Turn-On Time	t _{d(on)}	V _{DD} =400V, V _{GS} =10V	-	35	-	
Turri-Ori Tillie	t r	ν _{DD} =400V, V _{GS} =10V / _D =19.7A,	-	129	-	ns
Turn-Off Time	t _{d(off)}	$R_{\rm G}$ =12 Ω See Fig.3 and Fig.4	-	172	-	115
Turn-On Time	t f		-	27	-	
Total Gate Charge	Q _G	V _{DD} =400V, V _{GS} =10V I _D =39.4A See Fig.5	-	97	-	
Gate-Source Charge	Q GS		-	38	-	nC
Gate-Drain Charge	Q _{GD}		-	47	-	IIC
Drain-Source crossover Charge	Q sw		-	26	-	

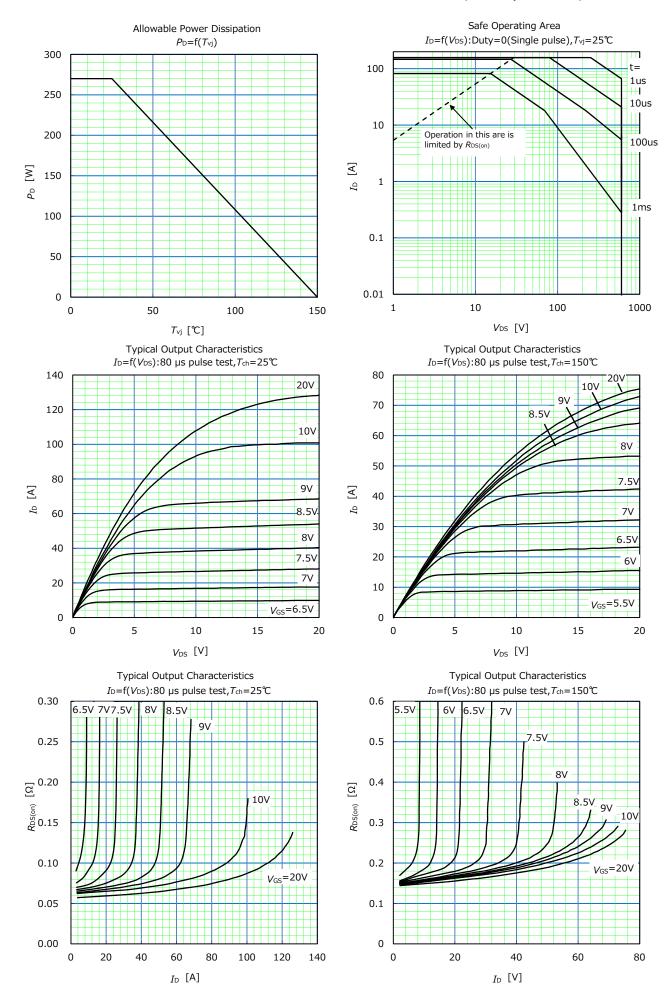
Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{Ds} is rising from 0 to 400V. Note *8 : $C_{0(fr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{Ds} is rising from 0 to 400V.

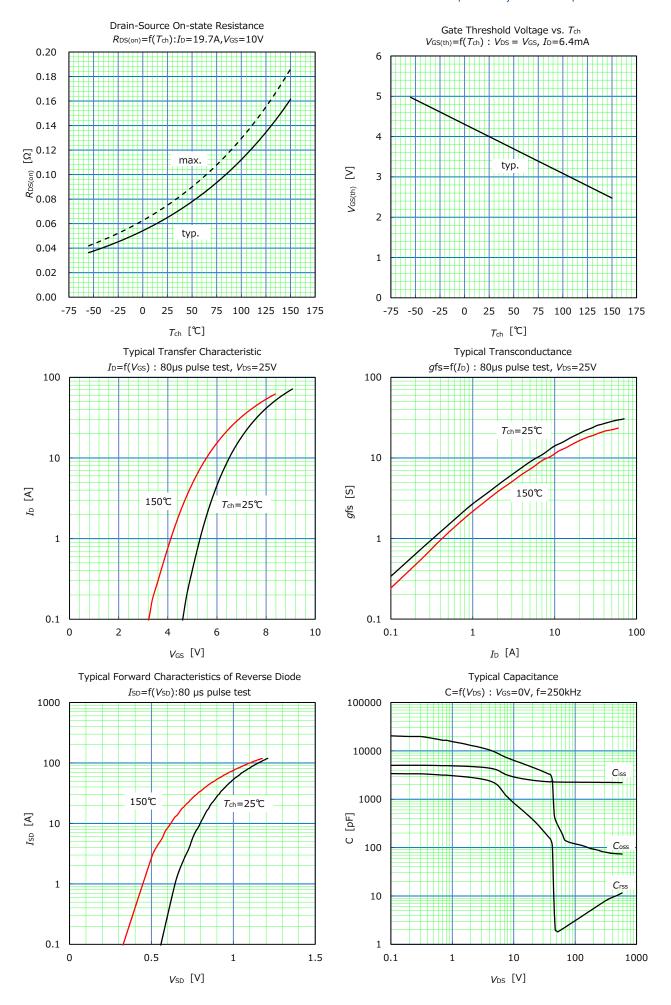
• Reverse Diode

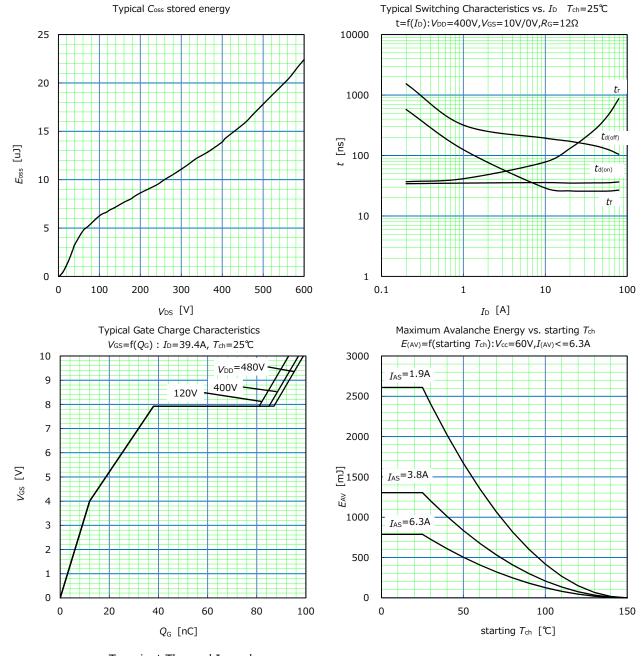
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{SD}	I _{SD} =39.4A, V _{SS} =0V T _{ch} =25°C	-	0.95	1.35	V
Reverse Recovery Time	t rr	- V _{DD} =400V, I _{SD} =39.4A -di/dt=100A/µs T _{ch} =25°C See Fig.6 and Fig.7	-	207	-	ns
Reverse Recovery Charge	Qrr		-	2.0	-	μC
Peak Reverse Recovery Current	I _{rp}		-	18.4	-	Α

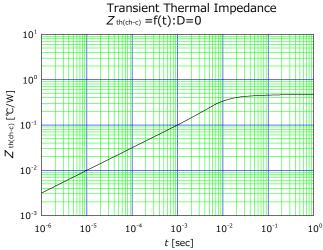
■ Thermal Resistance

Parameter	Symbol	Min.	Тур.	Max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.46	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	50	°C/W









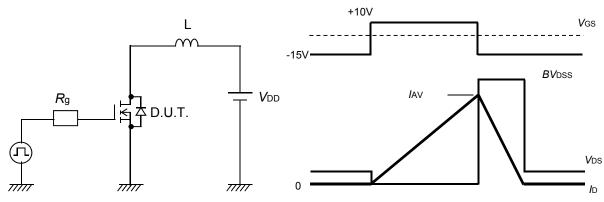


Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test

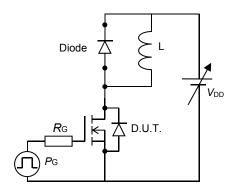


Fig.3 Switching Test circuit

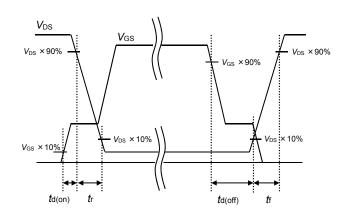


Fig.4 Operating waveform of Switching Test

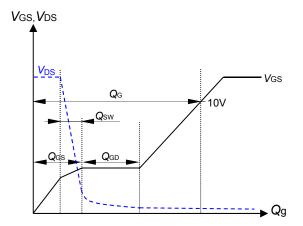


Fig.5 Operating waveform of Gate charge Test

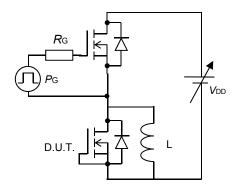


Fig.6 Reverse recovery Test circuit

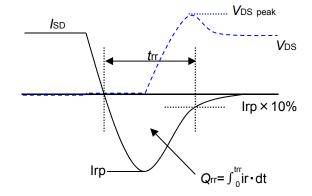
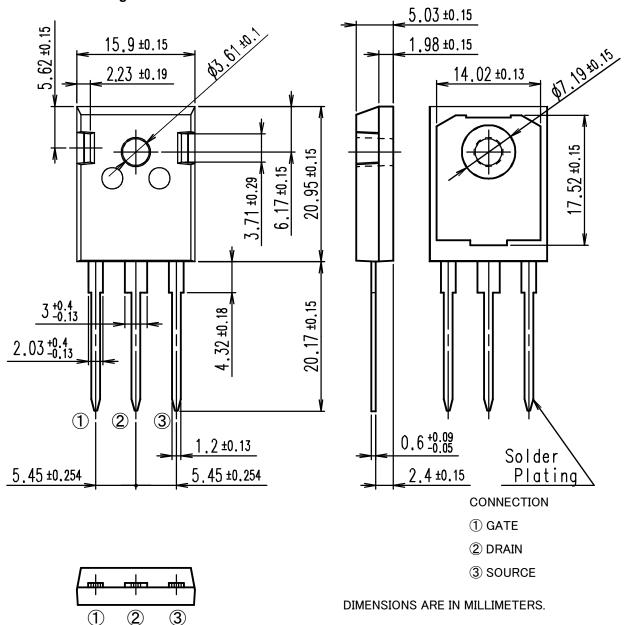
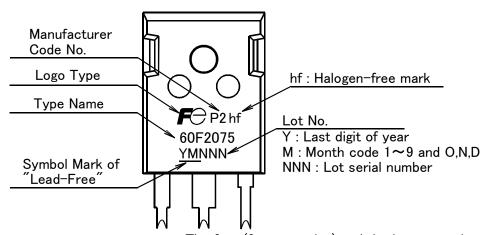


Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-247 Package



Marking



* The font (font type, size) and the logo type size might be actually different.

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- Machine tools
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- Electrical home appliances Persona
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